

# XB15A303



## PIN DIODE

Small Insertion Loss  
High Isolation  
Small Glass Package

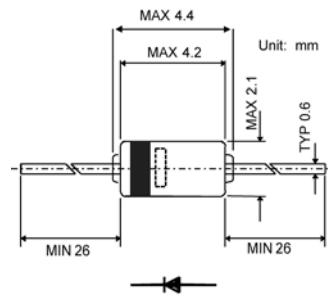
## APPLICATIONS

Antenna Switch

## GENERAL DESCRIPTION

The XB15A303 PIN diode employs a high reliability glass package that is designed for solid state antenna switches used in commercial two-way radios.

## DIMENSIONS



JEDEC DO-35

## ABSOLUTE MAXIMUM RATINGS

T<sub>a</sub> = 25

PARAMETER	SYMBOL	RATINGS		UNITS
Repetitive Peak Reverse Voltage	V <sub>RM</sub>	180		V
Forward Surge Current	I <sub>FSM</sub> *	2		A
Power Dissipation	P	500		mW
Junction Temperature	T <sub>j</sub>	175		
Storage Temperature Range	T <sub>stg</sub>	-55 ~ 175		

\* t = 5sec

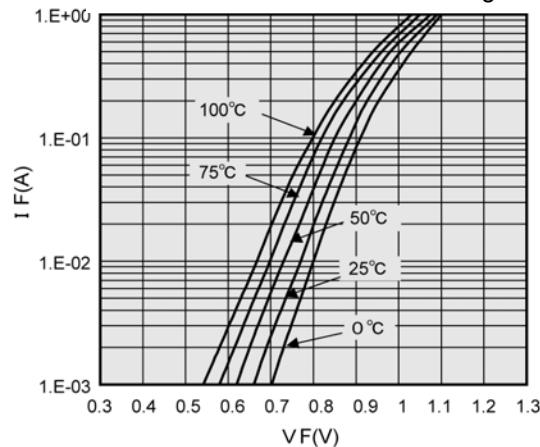
## ELECTRICAL CHARACTERISTICS

T<sub>a</sub> = 25

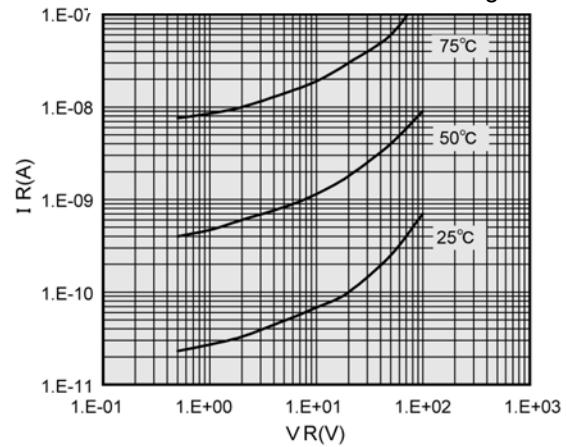
PARAMETER	SYMBOL	CONDITIONS	LIMITS			UNITS
			MIN.	TYP.	MAX.	
Reverse Current	I <sub>R1</sub>	V <sub>R</sub> = 180V	-	-	10	μA
	I <sub>R2</sub>	V <sub>R</sub> = 140V	-	-	150	nA
Forward Current	I <sub>F</sub>	V <sub>F</sub> = 1.0V	200	-	-	mA
Diode Capacitance	C <sub>t</sub>	V <sub>R</sub> = 0V, f = 1MHz	-	3.0	4.0	pF
Forward Series Resistance	r <sub>fs</sub>	I <sub>F</sub> = 20mA, f = 470MHz	-	0.6	1.0	
Cut-Off Frequency	f <sub>c</sub>	V <sub>R</sub> = 3V, f = 50MHz	900	-	-	MHz

## TYPICAL PERFORMANCE CHARACTERISTICS

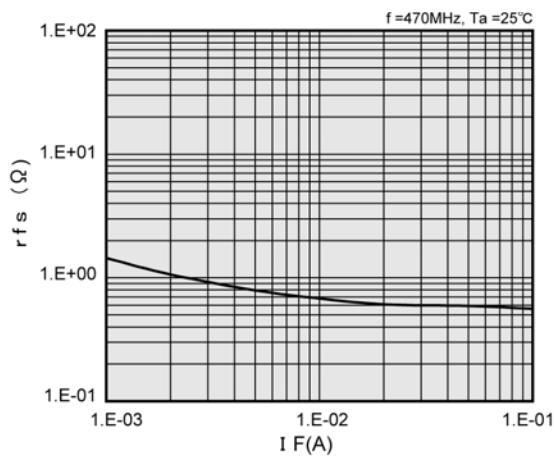
(1) Forward Current vs. Forward Voltage



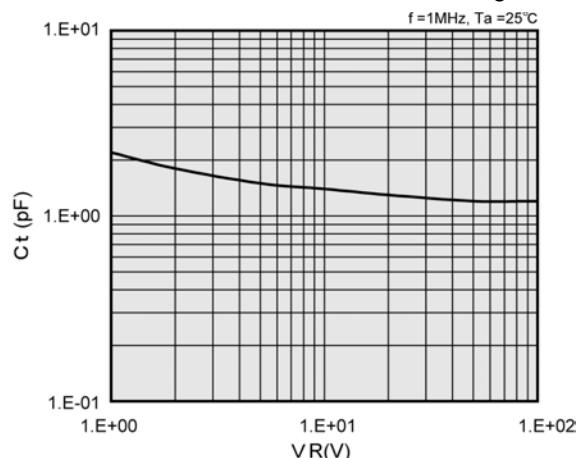
(2) Reverse Current vs. Reverse Voltage



(3) Forward Series Resistance vs. Forward Current



(4) Diode Capacitance vs. Reverse Voltage



(5) Cut-Off Frequency vs. Reverse Voltage

